

# United States Patent [19]

Burbank et al.

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[54] **ELECTRONIC CIRCUIT ENCLOSURE OR SIMILAR ARTICLE**

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[73] Assignee: **Motorola, Inc., Schaumburg, Ill.**

[\*\*] Term: **14 Years**

[21] Appl. No.: **353,745**

[22] Filed: **Mar. 1, 1982**

[52] U.S. Cl. .... **D13/40; D13/99**

[58] Field of Search ..... **D13/12, 40, 41, 99; 361/331, 332, 334, 380, 390-394; 174/50, 52 R, 66**

[56] **References Cited**

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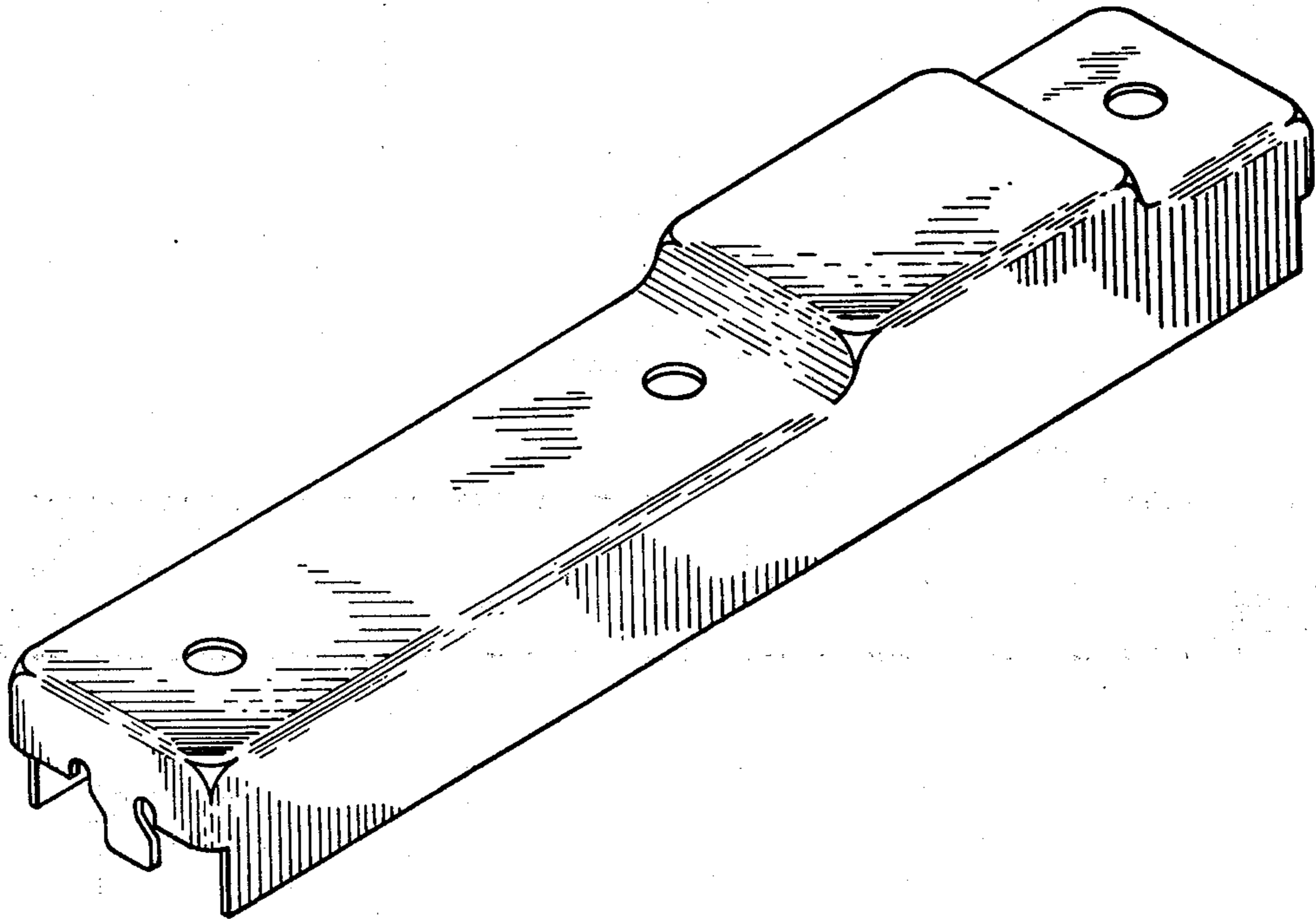
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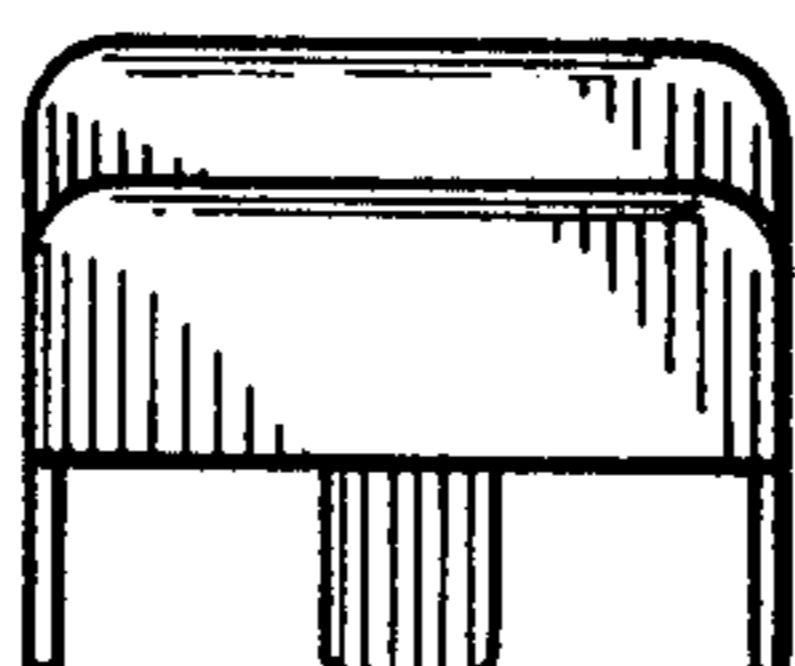
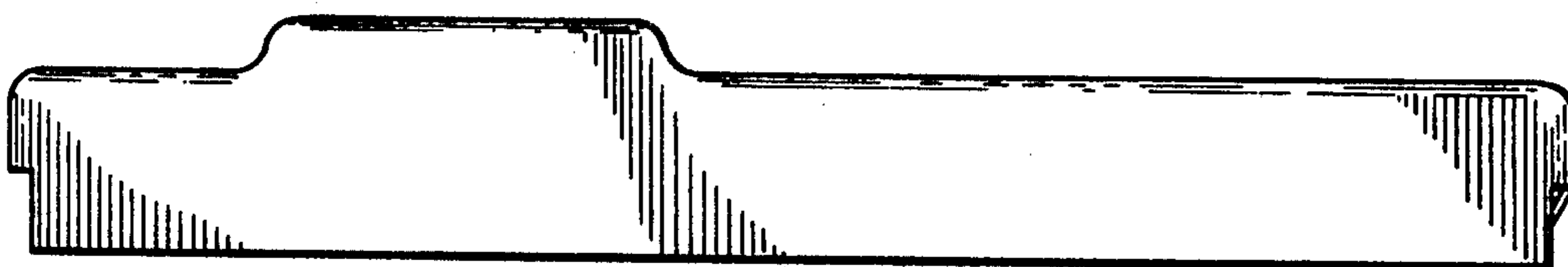
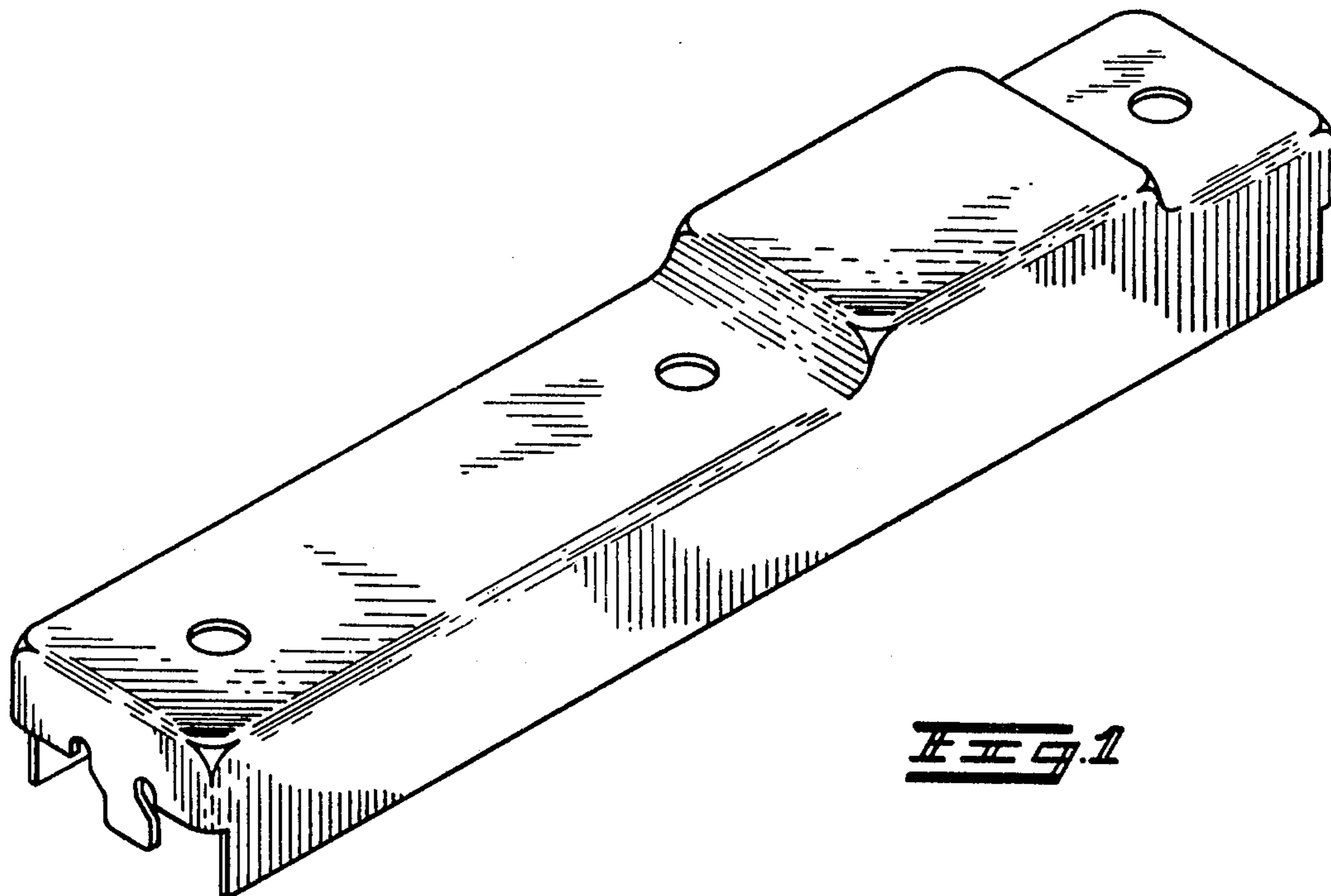
[57] **CLAIM**

The ornamental design for an electronic circuit enclosure or similar article, substantially as shown and described.

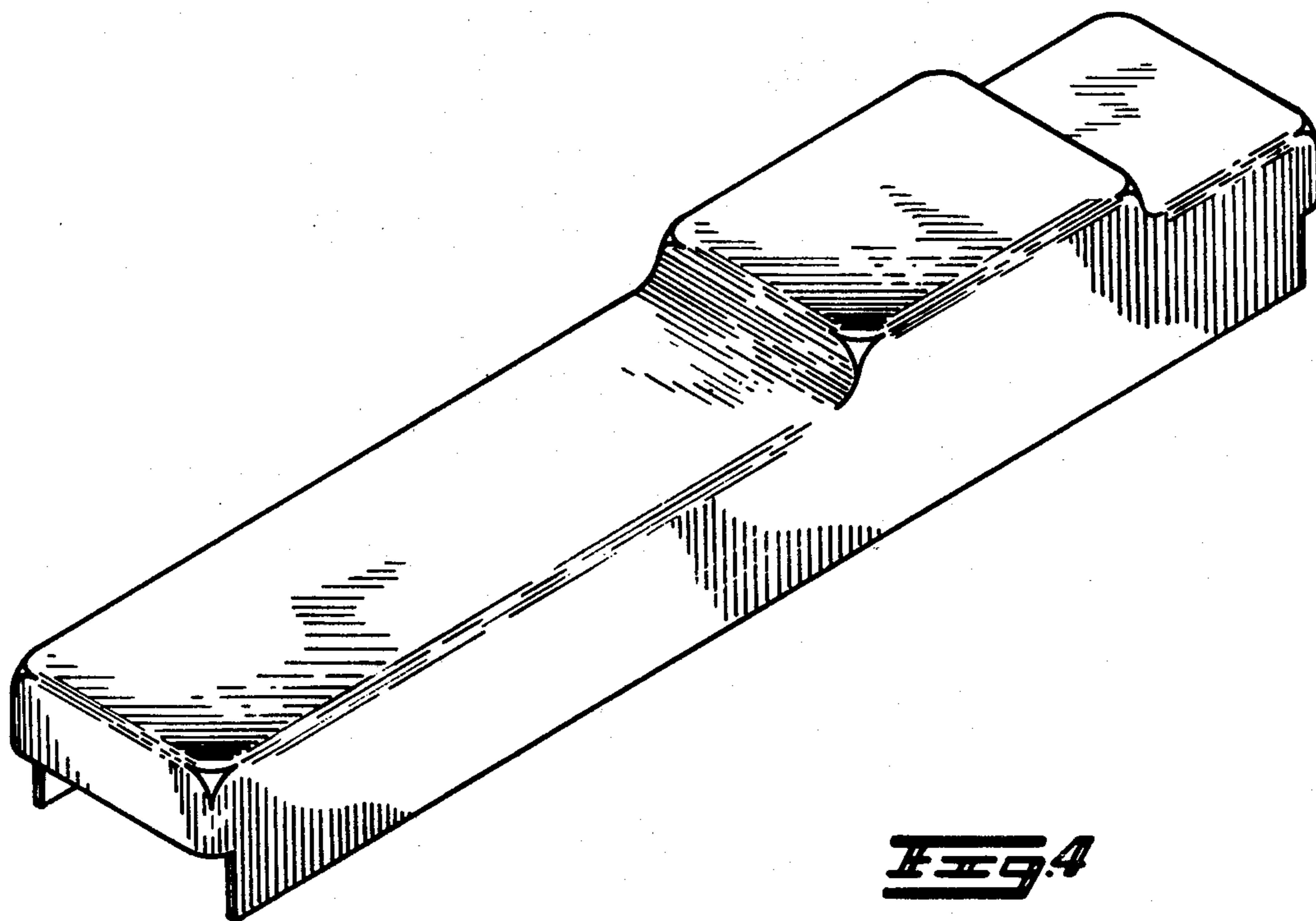
**DESCRIPTION**

FIG. 1 is a top perspective view of an electronic circuit enclosure or similar article showing our new design; FIG. 2 is a side elevational view as seen from the side opposite FIG. 1; FIG. 3 is a rear elevation view thereof; and FIG. 4 is a top perspective view of a modified embodiment of the electronic circuit enclosure or similar article illustrated in FIG. 1.





**FIG. 3**



**Fig. 4**